

RENEWAL OF MEMORANDUM OF UNDERSTANDING

BY AND BETWEEN

College of Electrical Engineering and Computer Science (EECS), National Taipei University of Technology (Taipei Tech) with its office at No. 1, Sec. 3, Zhongxiao E. Rd., Taipei 10608 Taiwan, R.O.C. (hereafter referred to as EECS)

AND

Sikkim Manipal Institute of Technology located at Majhitar, East Sikkim, Sikkim-737136, India (hereafter referred to as SMIT), a constituent college of Sikkim Manipal University with its office at 5th Mile, Tadong, East Sikkim, Sikkim-737102, India.

(EECS and SMIT are hereinafter collectively referred to as “Parties” and individually as “Party”.)

Both parties believe that the renewal of the collaboration between the two parties will benefit the organizations in the fields of academics and research.

Both the parties had entered into an agreement and signed a Memorandum of Understanding on 21st June 2018, and now the parties intend to renew the said Memorandum of Understanding for a further period of 5 years starting from 1st September 2023 to 1st September 2028.

Each party shall designate officials to serve as nodal officers for implementing this agreement. For EECS, the contact will be Prof. Yen-Sheng Chen (tel. +886-227712171, e-mail: yschen@ntut.edu.tw). For SMIT, the contact will be Dr. Samarendra Nath Sur (tel. +91-7908922292, e-mail: samarendra.s@smit.smu.edu.in).

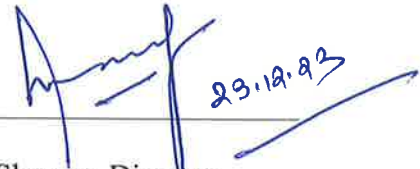
All other terms and conditions stipulated in the agreement dated 21st June 2018 between the parties remain unchanged.

Signed:



Prof. Yang-Lang Chang
College of EECS
National Taipei University of Technology
Taiwan

Signed:



Dr. G. L. Sharma, Director
Sikkim Manipal Institute of Technology
India.

Witnesses:

1.



2. Yen-Sheng Chen

Witnesses:

1.



2.

